

# NL17SHT126

## Noninverting Buffer / CMOS Logic Level Shifter with LSTTL-Compatible Inputs

The NL17SHT126 is a single gate noninverting 3-state buffer fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

The NL17SHT126 requires the 3-state control input (OE) to be set Low to place the output into the high impedance state.

The device input is compatible with TTL-type input thresholds and the output has a full 5 V CMOS level output swing. The input protection circuitry on this device allows overvoltage tolerance on the input, allowing the device to be used as a logic-level translator from 3 V CMOS logic to 5 V CMOS Logic or from 1.8 V CMOS logic to 3 V CMOS Logic while operating at the high-voltage power supply.

The NL17SHT126 input structure provides protection when voltages up to 7 V are applied, regardless of the supply voltage. This allows the NL17SHT126 to be used to interface 5 V circuits to 3 V circuits. The output structures also provide protection when  $V_{CC} = 0$  V. These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

### Features

- High Speed:  $t_{PD} = 3.5$  ns (Typ) at  $V_{CC} = 5$  V
- Low Power Dissipation:  $I_{CC} = 1$   $\mu$ A (Max) at  $T_A = 25^\circ\text{C}$
- TTL-Compatible Inputs:  $V_{IL} = 0.8$  V;  $V_{IH} = 2$  V
- CMOS-Compatible Outputs:  $V_{OH} > 0.8 V_{CC}$ ;  $V_{OL} < 0.1 V_{CC}$  @Load
- Power Down Protection Provided on Inputs and Outputs
- Balanced Propagation Delays
- Pin and Function Compatible with Other Standard Logic Families
- These are Pb-Free Devices

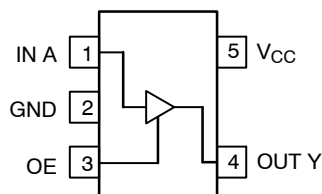


Figure 1. Pinout (Top View)

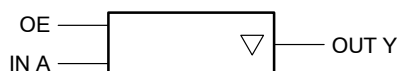


Figure 2. Logic Symbol



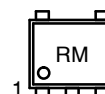
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<http://onsemi.com>

### MARKING DIAGRAM



**SOT-953  
CASE 527AE**



R = Specific Device Code  
M = Month Code

### PIN ASSIGNMENT

|   | PIN ASSIGNMENT |
|---|----------------|
| 1 | IN A           |
| 2 | GND            |
| 3 | OE             |
| 4 | OUT Y          |
| 5 | $V_{CC}$       |

### FUNCTION TABLE

| A Input | OE Input | Y Output |
|---------|----------|----------|
| L       | H        | L        |
| H       | H        | H        |
| X       | L        | Z        |

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

## MAXIMUM RATINGS

| Symbol        | Characteristics                           | Value                                          | Unit |
|---------------|-------------------------------------------|------------------------------------------------|------|
| $V_{CC}$      | DC Supply Voltage                         | -0.5 to +7.0                                   | V    |
| $V_{IN}$      | DC Input Voltage                          | -0.5 to +7.0                                   | V    |
| $V_{OUT}$     | DC Output Voltage                         | -0.5 to $V_{CC} + 0.5$                         | V    |
| $I_{IK}$      | Input Diode Current                       | -20                                            | mA   |
| $I_{OK}$      | Output Diode Current                      | $V_{OUT} < GND; V_{OUT} > V_{CC}$              | mA   |
| $I_{OUT}$     | DC Output Current                         | $\pm 25$                                       | mA   |
| $I_{CC}$      | DC Supply Current, $V_{CC}$ and GND       | 50                                             | mA   |
| $P_D$         | Power Dissipation in Still Air            | 50                                             | mW   |
| $T_L$         | Lead Temperature, 1 mm from Case for 10 s | 260                                            | °C   |
| $T_J$         | Junction Temperature Under Bias           | +150                                           | °C   |
| $T_{stg}$     | Storage Temperature                       | -65 to +150                                    | °C   |
| $I_{Latchup}$ | Latchup Performance                       | Above $V_{CC}$ and Below GND at 125°C (Note 1) | mA   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Tested to EIA/JESD78

## RECOMMENDED OPERATING CONDITIONS

| Symbol     | Characteristics             | Min                                        | Max      | Unit |
|------------|-----------------------------|--------------------------------------------|----------|------|
| $V_{CC}$   | DC Supply Voltage           | 3.0                                        | 5.5      | V    |
| $V_{IN}$   | DC Input Voltage            | 0.0                                        | 5.5      | V    |
| $V_{OUT}$  | DC Output Voltage           | 0.0                                        | $V_{CC}$ | V    |
| $T_A$      | Operating Temperature Range | -55                                        | +125     | °C   |
| $t_r, t_f$ | Input Rise and Fall Time    | $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ |          | ns/V |

## Device Junction Temperature versus Time to 0.1% Bond Failures

| Junction Temperature °C | Time, Hours | Time, Years |
|-------------------------|-------------|-------------|
| 80                      | 1,032,200   | 117.8       |
| 90                      | 419,300     | 47.9        |
| 100                     | 178,700     | 20.4        |
| 110                     | 79,600      | 9.4         |
| 120                     | 37,000      | 4.2         |
| 130                     | 17,800      | 2.0         |
| 140                     | 8,900       | 1.0         |

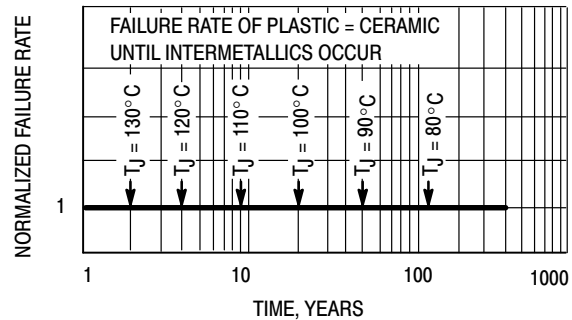


Figure 3. Failure Rate vs. Time Junction Temperature

# NL17SHT126

## DC ELECTRICAL CHARACTERISTICS

| Symbol           | Parameter                                                                                 | Test Conditions                                                                                              | V <sub>CC</sub><br>(V) | T <sub>A</sub> = 25°C |            |                    | T <sub>A</sub> ≤ 85°C |                    | -55 ≤ T <sub>A</sub> ≤ 125°C |                    | Unit |
|------------------|-------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------|------------------------|-----------------------|------------|--------------------|-----------------------|--------------------|------------------------------|--------------------|------|
|                  |                                                                                           |                                                                                                              |                        | Min                   | Typ        | Max                | Min                   | Max                | Min                          | Max                |      |
| V <sub>IH</sub>  | Minimum High-Level Input Voltage                                                          |                                                                                                              | 3.0<br>4.5<br>5.5      | 1.4<br>2.0<br>2.0     |            |                    | 1.4<br>2.0<br>2.0     |                    | 1.4<br>2.0<br>2.0            |                    | V    |
| V <sub>IL</sub>  | Maximum Low-Level Input Voltage                                                           |                                                                                                              | 3.0<br>4.5<br>5.5      |                       |            | 0.53<br>0.8<br>0.8 |                       | 0.53<br>0.8<br>0.8 |                              | 0.53<br>0.8<br>0.8 | V    |
| V <sub>OH</sub>  | Minimum High-Level Output Voltage<br>V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> = - 50 μA                            | 3.0<br>4.5             | 2.9<br>4.4            | 3.0<br>4.5 |                    | 2.9<br>4.4            |                    | 2.9<br>4.4                   |                    | V    |
|                  |                                                                                           | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> = - 4 mA<br>I <sub>OH</sub> = - 8 mA | 3.0<br>4.5             | 2.58<br>3.94          |            |                    | 2.48<br>3.80          |                    | 2.34<br>3.66                 |                    |      |
| V <sub>OL</sub>  | Maximum Low-Level Output Voltage<br>V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>  | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OL</sub> = 50 μA                              | 3.0<br>4.5             |                       | 0.0<br>0.0 | 0.1<br>0.1         |                       | 0.1<br>0.1         |                              | 0.1<br>0.1         | V    |
|                  |                                                                                           | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OL</sub> = 4 mA<br>I <sub>OL</sub> = 8 mA     | 3.0<br>4.5             |                       |            | 0.36<br>0.36       |                       | 0.44<br>0.44       |                              | 0.52<br>0.52       |      |
| I <sub>IN</sub>  | Maximum Input Leakage Current                                                             | V <sub>IN</sub> = 5.5 V or GND                                                                               | 0 to 5.5               |                       |            | ± 0.1              |                       | ± 1.0              |                              | ± 1.0              | μA   |
| I <sub>CC</sub>  | Maximum Quiescent Supply Current                                                          | V <sub>IN</sub> = V <sub>CC</sub> or GND                                                                     | 5.5                    |                       |            | 1.0                |                       | 20                 |                              | 40                 | μA   |
| I <sub>CCT</sub> | Quiescent Supply Current                                                                  | Input: V <sub>IN</sub> = 3.4 V<br>Other Input: V <sub>CC</sub> or GND                                        | 5.5                    |                       |            | 1.35               |                       | 1.50               |                              | 1.65               | mA   |
| I <sub>OPD</sub> | Output Leakage Current                                                                    | V <sub>OUT</sub> = 5.5 V                                                                                     | 0.0                    |                       |            | 0.5                |                       | 5.0                |                              | 10                 | μA   |
| I <sub>OZ</sub>  | Maximum 3-State Leakage Current                                                           | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>V <sub>OUT</sub> = V <sub>CC</sub> or GND            | 5.5                    |                       |            | ± 0.25             |                       | ± 2.5              |                              | ± 2.5              | μA   |

## AC ELECTRICAL CHARACTERISTICS Input t<sub>r</sub> = t<sub>f</sub> = 3.0 ns

| Symbol                                 | Parameter                                                                  | Test Conditions                                                                                                            | T <sub>A</sub> = 25°C |            |             | T <sub>A</sub> ≤ 85°C |              | -55 ≤ T <sub>A</sub> ≤ 125°C |              | Unit |
|----------------------------------------|----------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|-----------------------|------------|-------------|-----------------------|--------------|------------------------------|--------------|------|
|                                        |                                                                            |                                                                                                                            | Min                   | Typ        | Max         | Min                   | Max          | Min                          | Max          |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, A to Y<br>(Figures 3 and 5)                     | V <sub>CC</sub> = 3.3 ± 0.3 V    C <sub>L</sub> = 15pF<br>C <sub>L</sub> = 50pF                                            |                       | 5.6<br>8.1 | 8.0<br>11.5 | 1.0<br>1.0            | 9.5<br>13.0  |                              | 12.0<br>16.0 | ns   |
|                                        |                                                                            | V <sub>CC</sub> = 5.0 ± 0.5 V    C <sub>L</sub> = 15pF<br>C <sub>L</sub> = 50pF                                            |                       | 3.8<br>5.3 | 5.5<br>7.5  | 1.0<br>1.0            | 6.5<br>8.5   |                              | 8.5<br>10.5  |      |
| t <sub>PZL</sub> ,<br>t <sub>PZH</sub> | Maximum Output Enable Time, OE to Y<br>(Figures 4 and 5)                   | V <sub>CC</sub> = 3.3 ± 0.3 V    C <sub>L</sub> = 15pF<br>R <sub>L</sub> = R <sub>I</sub> = 500 Ω    C <sub>L</sub> = 50pF |                       | 5.4<br>7.9 | 8.0<br>11.5 | 1.0<br>1.0            | 9.5<br>13.0  |                              | 11.5<br>15.0 | ns   |
|                                        |                                                                            | V <sub>CC</sub> = 5.0 ± 0.5 V    C <sub>L</sub> = 15pF<br>R <sub>L</sub> = R <sub>I</sub> = 500 Ω    C <sub>L</sub> = 50pF |                       | 3.6<br>5.1 | 5.1<br>7.1  | 1.0<br>1.0            | 6.0<br>8.0   |                              | 7.5<br>9.5   |      |
| t <sub>PLZ</sub> ,<br>t <sub>PHZ</sub> | Maximum Output Disable Time, OE to Y<br>(Figures 4 and 5)                  | V <sub>CC</sub> = 3.3 ± 0.3 V    C <sub>L</sub> = 15pF<br>R <sub>L</sub> = R <sub>I</sub> = 500 Ω    C <sub>L</sub> = 50pF |                       | 6.5<br>8.0 | 9.7<br>13.2 | 1.0<br>1.0            | 11.5<br>15.0 |                              | 14.5<br>18.0 | ns   |
|                                        |                                                                            | V <sub>CC</sub> = 5.0 ± 0.5 V    C <sub>L</sub> = 15pF<br>R <sub>L</sub> = R <sub>I</sub> = 500 Ω    C <sub>L</sub> = 50pF |                       | 4.8<br>7.0 | 6.8<br>8.8  | 1.0<br>1.0            | 8.0<br>10.0  |                              | 10.0<br>12.0 |      |
| C <sub>in</sub>                        | Maximum Input Capacitance                                                  |                                                                                                                            |                       | 4          | 10          |                       | 10           |                              | 10           | pF   |
| C <sub>out</sub>                       | Maximum Three-State Output Capacitance<br>(Output in High Impedance State) |                                                                                                                            |                       | 6          |             |                       |              |                              |              | pF   |
| C <sub>PD</sub>                        | Power Dissipation Capacitance (Note 2)                                     | Typical @ 25°C, V <sub>CC</sub> = 5.0 V                                                                                    |                       |            |             |                       |              |                              |              | pF   |
|                                        |                                                                            | 14                                                                                                                         |                       |            |             |                       |              |                              |              |      |

2. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>/4 (per buffer). C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

## SWITCHING WAVEFORMS

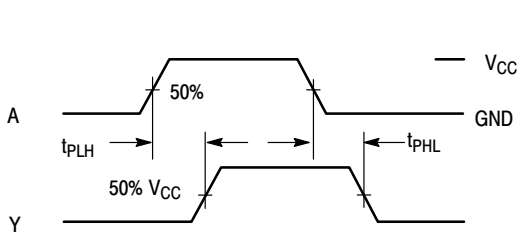


Figure 4. Switching Waveforms

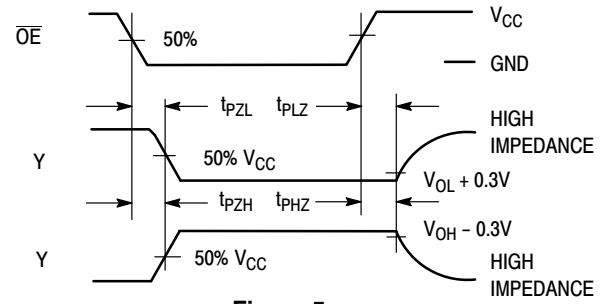


Figure 5.

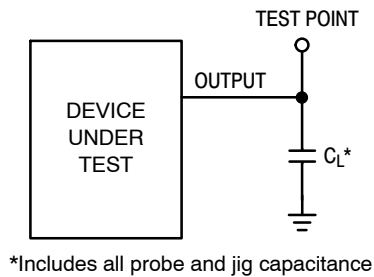


Figure 6. Test Circuit

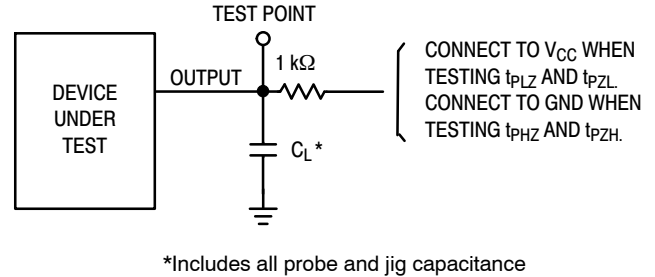


Figure 7. Test Circuit

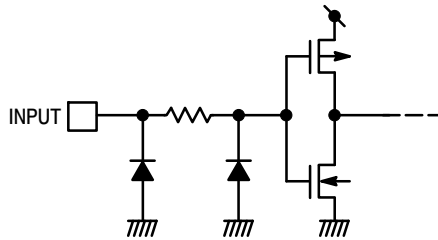


Figure 8. Input Equivalent Circuit

## ORDERING INFORMATION

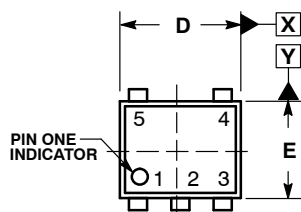
| Device          | Package              | Shipping <sup>†</sup> |
|-----------------|----------------------|-----------------------|
| NL17SHT126P5T5G | SOT-953<br>(Pb-Free) | 8000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

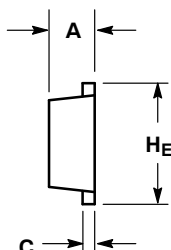
# NL17SHT126

## PACKAGE DIMENSIONS

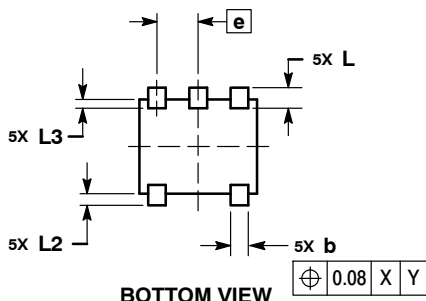
### SOT-953 CASE 527AE ISSUE E



TOP VIEW



SIDE VIEW



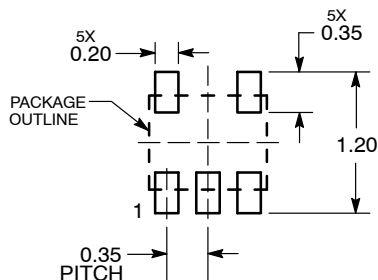
BOTTOM VIEW

#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| MILLIMETERS    |           |      |      |
|----------------|-----------|------|------|
| DIM            | MIN       | NOM  | MAX  |
| A              | 0.34      | 0.37 | 0.40 |
| b              | 0.10      | 0.15 | 0.20 |
| C              | 0.07      | 0.12 | 0.17 |
| D              | 0.95      | 1.00 | 1.05 |
| E              | 0.75      | 0.80 | 0.85 |
| e              | 0.35 BSC  |      |      |
| H <sub>E</sub> | 0.95      | 1.00 | 1.05 |
| L              | 0.175 REF |      |      |
| L2             | 0.05      | 0.10 | 0.15 |
| L3             | ---       | ---  | 0.15 |

#### SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
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Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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